



Product Guide

February 2011

IBM BladeCenter HS22

Product Overview

No-compromise, truly balanced, 2-socket blade server for infrastructure, virtualization and enterprise business applications

Suggested uses: Front-end and mid-tier applications requiring high performance, enterpriseclass availability and extreme flexibility and power efficiency.

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Today's data center environment is tougher than ever. You're looking to reduce IT cost, complexity, space requirements, energy consumption and heat output, while increasing flexibility, utilization and manageability. Incorporating IBM **X-Architecture**[™] features, the **IBM**[®] **BladeCenter HS22** blade server, combined with the various BladeCenter chassis, can help you accomplish all of these goals.

Reducing an entire server into as little as .5U of rack space (i.e., up to 14 servers in 7U) does not mean trading away features and capabilities for smaller size. Each HS22 blade server offers features comparable to many 1U rack-optimized full-featured servers: The HS22 supports up to two of the latest high-performance or low-voltage 6-core, 4-core, and 2-core Intel® Xeon® 5500 series and 5600 series processors. The Xeon processors are designed with up to 12MB of shared cache and leading-edge memory performance (up to 1333MHz, depending on processor model) to help provide the computing power you require to match your business needs and growth. The HS22 supports up to 192GB of registered double data rate III (DDR3) ECC (Error Checking and Correcting) memory in 12 DIMM slots, with optional Chipkill® protection¹, for high performance and reliability. Selected models are planned for NEBS-3/ETSI-compliance.

The HS22 offers an option for **VMware vSphere Hypervisor** (formerly ESXi) **preloaded** on a standard USB flash drive. It operates in a diskless configuration, offers a smaller memory footprint, extremely high performance, and stronger security, making getting a system up and running in a virtualized environment faster and easier than ever before.

An integrated dual-port Gigabit Ethernet² controller is standard, providing high-speed data transfers and offering TOE (TCP Offload Engine) support, load-balancing and failover capabilities. Via optional expansion cards, each blade can also connect to additional Ethernet, SAS, Fibre Channel, iSCSI, InfiniBand, and other high-speed communication switches housed in the chassis. Optional 2-port and 4-port Expansion Cards add additional fabrics to the HS22 server as needed. This blade is designed with power management capability to provide the maximum uptime possible for your systems. In extended thermal conditions or power brownouts, rather than shut down completely, or fail, the HS22 automatically reduces the processor frequency to maintain acceptable thermal and power levels.

All HS22 models offer impressive features at an equally impressive price, including up to **two hot-swap SAS or SATA hard disk drives** or **two hot-swap solid-state drives** with **RAID-0/1/1E** support, and one USB-based internal flash drive (for embedded hypervisor]. Additional storage is available via the BladeCenter S chassis. Moreover, the HS22 is **optimized** for diskless operation, offering each blade server access to essentially unlimited external storage capacity via Fibre Channel, SAS, or iSCSI.

A single BladeCenter E or BladeCenter H chassis supports up to 14 hot-swappable 30mm-wide HS22 blades in only 7U (BladeCenter E) or 9U (BladeCenter H) of rack space or up to 12 in the 12U BladeCenter HT high-speed telecommunications chassis. In addition to the blade servers, these chassis also hold up to 4 switches (BladeCenter E) or up to 10 (BladeCenter H) or 8 switches/bridges (BladeCenter HT) internally. The BladeCenter S, designed for SMB and mid-market customers, takes integration and affordability to a new level, combining up to 12 hot-swap SAS/SATA HDDs (with optional SAS card) and up to 6 blade servers and 4 switches. Not only can this save significant data center space (and therefore the cost of floor space and rack hardware) compared to 1U servers, it also consolidates switches/bridges and cables for reduced complexity and lower cabling costs, and it allows clients to manage

¹ Chipkill protection on the HS22 requires x4 DIMMs; Chipkill protection is *not* available with x8 DIMMs.

² Actual data transfer speed will vary and is often less than the maximum possible. Gigabit Ethernet transfer speed requires support on both system and server, and appropriate network infrastructure.

everything in the solution as one. Using a BladeCenter E chassis, up to **84** HS22 servers (**168** processors) can be installed in one **industry-standard 42U** rack; but the value of BladeCenter extends far beyond high density data center environments.

The various BladeCenter chassis are designed to monitor environmental conditions in the chassis and each blade and send alerts to the administrator. Advanced standard features, such as Active Memory™, Predictive Failure Analysis™, light path diagnostics, hot-swap redundant hard disk drives, power supplies and blower modules with Calibrated Vectored Cooling™; IPMI 2.0 support, including highly secure remote power control; text-console redirect over LAN, next-generation BIOS (UEFI), an Advanced Management Module (upgradeable with a redundant AMM), IBM Systems Director management software including IBM Systems Director Active Energy Manager™ for x86. Remote Deployment Manager, and IBM ServerGuide™ help maintain system availability with increased uptime.

If you need highly manageable, high-performance computing power in a space- or power-constrained environment, the HS22 is the ideal system.

Selling Features

Price/Performance

- There is an HS22 model to fit all budgets. The HS22 offers a choice of high-performance 6-core/4-core/2-core Xeon processors with integrated memory controllers, clock rates from 1.6GHz to 3.6GHz, and from 3MB to 12MB of shared cache (processor-specific) of integrated L3 cache. Xeon 5600 series processors offer up to 60% better performance³ than the previous-generation 5500 series processors and up to 1500% better performance than the single-core processors of a few years ago that you may still be using.
- Low-voltage processors draw less energy and produce less waste heat than higher-voltage processors, thus helping to reduce data center energy costs. On a per-core basis, the standard 80W processors are extremely economical, consuming as little as 13.33W per core. Some low-voltage Xeon processors consume only 10W per core (4-core 40W or 6-core 60W).
- Up to 192GB of registered DDR3 ECC memory operates at 800MHz to 1333MHz (depending on the system configuration), for high performance and wide memory bandwidth.
- Run two DIMMs per memory channel at 1333MHz in specific 5600 series processor configurations
- Embedded virtualization (optional on all models) offers extremely high performance, enhanced security, and a zero-gigabyte HDD footprint. (In other words, no mechanical HDD to fail.)
- Optional solid-state drives (SDDs) use only 2W of energy per drive, vs. 7-10W for 2.5-inch HDDs.
 This is as much as 80% less energy than a HDD would use (with a corresponding reduction in heat
 output).
- Low-voltage 1.35V memory draws up to 19% less power than 1.5V DIMMs.
- Selected HS22 blade servers are planned for NEBS3/ETSI-compliance and feature long-life availability. These blades are ideal for telecom or Next Generation Network (NGN) applications such as IPTV, IP Multimedia Subsystem (IMS) and security.
- The extremely high degree of integration in the various BladeCenter chassis reduces the need
 for server components, replacing numerous fans, KVM and Ethernet cables, power supplies,
 external switches and other components with fewer shared hot-swap/redundant components in the
 BladeCenter chassis itself. This integration also can greatly reduce the amount of power
 consumed and heat produced, relative to an equivalent number of 1U servers. This can
 significantly reduce a data center power bill. The reduced datacenter footprint can also save on
 infrastructure cost.
- The midplanes used in all chassis provide high-speed blade-to-blade, blade-to-switch-module
 and module-to-module communications internally as well as externally. The midplanes used in
 the BladeCenter H and BladeCenter HT chassis provide four 10Gb data channels to each blade,
 and supports high-speed switch modules, including 4X InfiniBand and 10Gb Ethernet.
- The various BladeCenter chassis use ultrahigh efficiency power supplies. Many industry-standard servers use power supplies that are only 70-80% efficient at converting power from AC wall current to the DC power used inside servers. BladeCenter power modules are up to 94% efficient (and meet the 80 Plus® Platinum Standard). This helps save even more money, as more of the power input you are paying for is used for processing, rather than released into the data center as waste heat that requires even more energy to cool.
- BladeCenter also reduces the number of parts required to run the system. Sharing fans, systems management, floppy devices and media means fewer parts to buy and maintain, and fewer items that can fail and bring the overall solution down.

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³ Based on Intel measurements.

Flexibility

The HS22 has the ability to grow with your application requirements, thanks to:

- Up to two multi-core Xeon processors (up to twelve cores per server).
- A choice of processor speeds from 1.6 to 3.6GHz, up to 12MB of shared cache, and a choice of power draw from 40W to 130W.
- A choice of memory speeds from 800MHz to 1333MHz.
- Up to 192GB of system memory in 12 DIMM slots.
- Two internal hot-swap 2.5-inch SAS or SATA HDDs or solid state drives, and access to terabytes of external IBM System Storage SAN and NAS storage devices. 2.5-inch drives consume approximately half the power of 3.5-inch drives.
- Two Gigabit Ethernet ports standard; plus more, using either a 2-port or 4-port Gigabit Ethernet Expansion Card or a BladeCenter PCI Express I/O Expansion Unit.

In addition, the various BladeCenter chassis offer a high degree of flexibility:

- A 30mm HS22 blade server can be upgraded, via a planned PCI Express I/O Expansion Unit. This
 expandability allows configurations that are 30mm or 60mm wide, with a variety of I/O options,
 depending on need.
- When installed in a BladeCenter H high-speed switch bay, the optional Multi-Switch Interconnect
 Module doubles the number of Gigabit Ethernet and Fibre Channel connections to every blade in
 the chassis (up to 8 or 12 ports, depending on the blade server).
- Xeon processor-based HS22 blades can be used in the same chassis as Intel processor-based HC10, HS12, HS20, HS21, HS21 XM, HS40, and HX5 blades; AMD Opteron processor-based LS20, LS21, LS22, LS41 and LS42 blades; IBM PowerPC® processor-based JS20, JS21, and JS22 blades; POWER6® processor-based JS12, JS23, and JS43 Express blades; POWER7® processor-based PS700, PS701, and PS702 blades; Cell Broadband Engine™ processor-based QS21; and IBM PowerXCell™ processor-based QS22 blades. Depending on the blade servers used, the various BladeCenter chassis support Microsoft® Windows®, Linux®, Novell Netware, IBM AIX® IBM i, and Sun Solaris 10 operating systems in the same chassis.
- Most HS/LS/JS/PS/QS blade servers ever released by IBM are are supported in every BladeCenter chassis ever released, going back to 2002⁴.. Every switch module released by IBM is equally compatible. (Ask HP and Dell how far back their compatibility goes.)
- A blade server has access to as many as 10 communication switches/bridges in a BladeCenter H or 8 in a BladeCenter HT chassis. (Up to 4 switches in a BladeCenter E chassis.) And the switches can be Ethernet, iSCSI, SAS, InfiniBand, Fibre Channel, or anything else designed and ServerProven® for BladeCenter use. Switches, bridges and interface cards are currently available from such vendors as Brocade, Cisco, Intel, QLogic, Voltaire, and others, in addition to IBM/BNT.

Manageability

- The HS22 blade server includes an Integrated Management Module (IMM) to monitor server availability, perform Predictive Failure Analysis, etc., and trigger IBM Systems Director alerts. The IMM performs the functions of both the Baseboard Management Controller (BMC) of earlier systems, and the Remote Supervisor Adapter II, as well as remote presence/cKVM.
- Each BladeCenter chassis includes an Advanced Management Module to provide additional
 systems management capabilities, including Web-based out-of-band control; virtual floppy and CDROM support; Windows "blue screen" error capture; LDAP and SSL support; and remote redirection
 of video, text, keyboard and mouse.
- Integrated industry-standard Unified Extensible Firmware Interface (UEFI) next-generation BIOS.
 New capabilities include:
 - ☐ Human readable event logs no more beep codes
 - □ Complete setup solution by allowing adapter configuration function to be moved into UEFI
 - ☐ Complete out-of-band coverage by the Advance Settings Utility to simplify remote setup
- Integrated industry-standard IPMI 2.0 support works with the IMM to alert IBM Systems Director to anomalous environmental factors, such as voltage and thermal conditions. It also supports highly secure remote power control.
- Integrated Trusted Platform Module (TPM) 1.2 support.
- IBM Systems Director Active Energy Manager, an IBM-exclusive, is designed to take
 advantage of new system power management features, by monitoring actual power usage and
 providing power consumption capping features. More accurate power usage data helps with data

⁴ Some older chassis may require power module and management module upgrades. But the chassis itself, as well as fan/blower modules and other components, are fully compatible.

- center construction planning and the sizing of power and cooling needs, as well as allowing you to use available power more efficiently.
- The HS22 supports remote presence/concurrent KVM (cKVM) and concurrent media (cMedia) access by multiple administrators at once, via the IMM.
- IBM Systems Director is included for proactive systems management and works with both the blade's
 internal IMM and the chassis' management module. It comes with a portfolio of tools, including IBM
 Systems Director Active Energy Manager, Service and Support Manager, and others. In
 addition, IBM Systems Director offers extended systems management tools for additional server
 management and increased availability. When a problem is encountered, IBM Systems Director can
 issue administrator alerts via e-mail, pager, and other methods.

Availability and Serviceability

- BladeCenter chassis are designed for operation with greatly reduced potential for single points of failure. Most aspects of operation, from blade servers to communication modules, to management modules, to power and blower modules, are hot-swappable. The midplane connections are redundant and the other features can be made so, when used in pairs.
- HS22 blade servers support the use of Chipkill-enabled ECC (error checking and correcting)
 memory. Chipkill memory can be up to 16X better than standard ECC memory at correcting some
 types of memory errors. This can help reduce downtime caused by memory errors. Optional memory
 mirroring and memory sparing offer additional redundancies.
- Solid-state drives offer up to triple the availability (MTBF rates) of conventional SAS HDDs. This can lessen the need for redundant drives.
- IPMI 2.0 supports highly secure remote system power on/off using data encryption. This allows an
 administrator to restart a server without having to visit it in person, saving travel time and getting the
 server back up and running quickly and securely.
- Environmentally tuned blower modules in the chassis adjust to compensate for changing thermal characteristics. At the lower speeds they draw less power and suffer less wear. Equally important in a crowded data center, temperature-controlled blowers produce less ambient noise in the data center than if they were constantly running at full speed.
- Text and graphics console redirection support allows the administrator to remotely view HS22 text and graphic messages over serial or LAN connections.
- A standard three-year (parts and labor) limited onsite warranty⁵ affords you peace of mind and greater potential investment protection.

Right, Open, Easy, Green

You need to make IT decisions that will drive business success. You face management challenges and technological complexity such as space constraints, power and cooling limitations, heterogeneous environments and I/O connectivity issues. IBM brings together the widest choice of compatible chassis, blade servers, storage and networking offerings and solution providers in the industry to help you build an open and flexible IT environment. And regardless of the size of your business, you want to be up and running 24/7. With built-in redundancy, innovative power and cooling and the latest I/O and management tools, IBM BladeCenter is easy to own—so you can focus on your business demands and stay ahead of the competition.

The **RIGHT** choice, tailored to fit your diverse needs:

- It's flexible and modular. As needs evolve, a one-size-fits-all solution doesn't work.
 - Meet your needs with BladeCenter: everything from a high-performance data center to a small office with limited IT skills—IBM has you covered
 - Get flexibility with 5 compatible chassis and 5 blade types supporting multiple I/O fabrics, all managed from a common point
- It's robust and reliable, providing redundancy throughout and the information you need to keep your business up and running.
 - Provide redundancy for no single point of failure with IBM BladeCenter
 - Preserve application uptime with IBM Predictive Failure Analysis[®] and light path diagnostics
 - Make decisions based on accurate data for quick problem diagnosis with First Failure Data Capture

OPEN and innovative, for a flexible business foundation:

 It's comprehensive, providing broad, fast, and reliable networking and storage I/O with BladeCenter Open Fabric.

⁵ For terms and conditions or copies of the IBM Statement of Limited Warranty, call 800-772-2227 in the U.S. In Canada call 800-426-2255. Telephone support may be subject to additional charges. For warranties including onsite labor, a technician is sent after IBM attempts to resolve the problem remotely. International warranty service is available in any country in which this product is sold.

- Match your data center needs and the appropriate interconnect using a common management point, and 5 I/O fabrics to choose from
- Extract the most from your third-party management solutions by utilizing the BladeCenter Open Fabric Manager
- It's collaborative, enabling you to harness the power of the industry to deliver innovation that matters.
 - Get flexibility from a myriad of solutions created by Blade.org members and industry leaders that have downloaded our open specification

EASY to deploy, integrate and manage:

- It enables efficient integrated management, which allows you to minimize costs with the tools you need for effective management.
 - Automate OS installation and BIOS updates remotely with IBM Systems Director tools
 - Administer your blades at the chassis or rack level with the Advanced Management Module
 - Plug into your enterprise management software
- It enable deployment simplicity without tradeoffs by speeding the deployment of new hardware in minutes rather than days, using BladeCenter Open Fabric Manager
 - Get significantly faster deployment of servers and I/O than from rack solutions
 - Reduce costly downtime with integrated failover capability
 - Manage from a single point of control via the Advanced Management Module
 - Use with virtually all IBM switches, blades and chassis

GREEN today for a better tomorrow:

- It offers control via powerful tools that help you optimize your data center infrastructure so you can be responsive.
 - Understand your power requirements with IBM Power Configurator
 - Monitor, control and virtualize your power with IBM Systems Director Active Energy Manager
 - Reduce data center hot spots with the IBM Rear Door Heat eXchanger
 - Optimize and future-proof your data center with IBM Data Center Energy Efficiency services
- Our eco-friendly servers and services can help you be environmentally responsible.
- · Become more energy efficient with IBM expertise

Key Features

Multicore Intel Xeon Processors

The HS22 supports up to **two** identical Xeon 5600 series or 5500 series processors. Each processor contains a memory controller (meaning two in a two-processor system) for superior performance. (Some processor models are available via CTO only.)The choice of processors includes:

- 130W 6-core Xeon 5600 series models X5690 or X5680 running at 3.46 or 3.33GHz (respectively), with impressive performance/watt (21.67W per core; 6.4GTps QPI speed), 12MB of L3 processor cache, 1333MHz memory access, 2 threads per core, and Intel Turbo Boost technology; supported in all BladeCenter chassis, except BladeCenter T
- 130W 4-core Xeon 5600 series model X5677 running at 3.46GHz, with impressive performance
 (32.5W per core; 6.4GTps QPI speed), 12MB of L3 processor cache, 1333MHz memory access, 2
 threads per core, and Intel Turbo Boost technology; supported in all BladeCenter chassis, except
 BladeCenter T
- 95W six-core Xeon 5600 series models X5675 or X5670 running at 3.06 or 2.93GHz (respectively), with impressive performance/watt (15.84W per core; 6.4GTps QPI speed), 12MB of shared L3 cache, 1333MHz memory access, 2 threads per core, and Intel Turbo Boost technology; supported in all BladeCenter chassis, except BladeCenter T
- 95W 4-core Xeon 5600 series model X5672 running at 3.2GHz with reduced power draw and
 excellent performance/watt (only 23.75W per core; 6.4GTps QPI speed), 12MB of L3 processor
 cache, 1333MHz memory access, 2 threads per core, and Intel Turbo Boost technology and Hyper
 Threading Technology; supported in all BladeCenter chassis, except BladeCenter T
- 95W four-core Xeon 5600 series model X5667 running at 3.06GHz, with excellent performance/watt
 (23.75W per core; 6.4GTps QPI speed), 12MB of shared L3 cache, 1333MHz memory access, 2
 threads per core, and Intel Turbo Boost technology; supported in all BladeCenter chassis, except
 BladeCenter T
- 80W 6-core Xeon 5600 series model E5649 running at 2.53GHz, with reduced power draw and impressive performance/watt (only 13.33W per core; 5.86GTps QPI speed), 12MB of L3 processor cache, 1333MHz memory access, 2 threads per core, and Intel Turbo Boost technology
- 130W 4-core Xeon 5600 model X5647 running at 2.93GHz with impressive performance (32.5W per core; 5.86GTps QPI speed), 12MB of L3 processor cache, 1066Hz memory access, 2 threads per



- core, and Intel Turbo Boost technology; supported in all BladeCenter chassis, except BladeCenter E and BladeCenter T
- 60W four-core Xeon 5600 series model L5640 at 2.26GHz, with low power draw and impressive
 performance/watt (only 10W per core; 5.86GTps QPI speed), 12MB of shared L3 cache, 1333MHz
 memory access, 2 threads per core, and Intel Turbo Boost technology; supported in all BladeCenter
 chassis, except BladeCenter T
- 80W four-core Xeon 5600 series models E5640 and E5620 at 2.66 and 2.4GHz, with reduced power draw and impressive performance/watt (only 20W per core; 5.86GTps QPI speed), 12MB of shared L3 cache, 1066MHz memory access, 2 threads per core, and Intel Turbo Boost technology; supported in all BladeCenter chassis, except BladeCenter T
- 40W 4-core Xeon 5600 series low-voltage model L5609 running at 1.86GHz, with extremely low power draw and amazing performance/watt (only 10W per core; 4.8GTps QPI speed), 12MB of L3 processor cache, and 1066MHz memory access; supported in all BladeCenter chassis
- 80W 4-core Xeon 5600 series model E5607 running at 2.26GHz, with reduced power draw and impressive performance/watt (20W per core; 4.8GTps QPI speed), 8MB of L3 processor cache, and 1066MHz memory access
- 80W 4-core Xeon 5600 series model E5603 running at 1.6GHz, with reduced power draw and impressive performance/watt (20W per core; 4.8GTps QPI speed), 8MB or 4MB (respectively) of L3 processor cache, and 1066MHz memory access
- 80W four-core Xeon 5500 series model E5507 at 2.26GHz, with reduced power draw and impressive performance/watt (only 20W per core; 4.8GTps QPI speed), 4MB of shared L3 cache, and 800MHz memory access; supported in all BladeCenter chassis, except BladeCenter T
- 80W two-core Xeon 5500 series model E5503 at 2.0GHz, with reduced power draw and impressive
 performance/watt (only 20W per core; 4.8GTps QPI speed), 4MB of shared L3 cache, and 800MHz
 memory access; supported in all BladeCenter chassis, except BladeCenter T

Also available, via configure-to-order (CTO):

- 130W 4-core Xeon 5600 series model X5687 running at 3.6GHz, with impressive performance
 (32.5W per core; 6.4GTps QPI speed), 12MB of L3 processor cache, 1333MHz memory access, 2
 threads per core, and Intel Turbo Boost technology; supported in all BladeCenter chassis, except
 BladeCenter E and BladeCenter T
- 80W 6-core Xeon 5600 series models E5645 at 2.4GHz, with reduced power draw and impressive performance/watt (only 13.33W per core; 5.86GTps QPI speed), 12MB of shared L3 cache, 1333MHz memory access, 2 threads per core, and Intel Turbo Boost technology; supported in all BladeCenter chassis, except BladeCenter T
- 60W 6-core Xeon 5600 series low-voltage model L5630 running at 2.0GHz, with low power draw
 and amazing performance/watt (only 10W per core; 5.86GTps QPI speed), 12MB of L3 processor
 cache, and 1066MHz memory access; supported in all BladeCenter chassis, except BladeCenter T
- 80W 4-core Xeon 5600 series model E5606 running at 2.13GHz, with reduced power draw and impressive performance/watt (20W per core; 4.8GTps QPI speed), 8MB of L3 processor cache, and 1066MHz memory access; supported in all BladeCenter chassis, except BladeCenter T

Also available, via special bid:

40W 4-core Xeon 5600 series low-voltage model L5618 running at 1.86GHz, with extremely low
power draw and amazing performance/watt (only 10W per core; 5.86GTps QPI speed), 12MB of L3
processor cache, and 1066MHz memory access, 2 threads per core, and Intel Turbo Boost
technology; supported in all BladeCenter chassis, except BladeCenter T

Note: Because of the integrated memory controllers the former front-side bus (FSB) no longer exists

With the Xeon 5500 series and 5600 series processors, Intel has diverged from its traditional Symmetric Multiprocessing (SMP) architecture to a Non-Uniform Memory Access (NUMA) architecture. The Xeon 5500 and Xeon 5600 processors are connected through a serial coherency link called QuickPath Interconnect (QPI). QPI is capable of 6.4, 5.6 or 4.8 GTps (gigatransfers per second), depending on the processor model.

The **six-core Xeon** processors contain **six complete processor cores**. The processors also contain one shared **12MB** cache. The shared cache is dynamically allocated among cores as needed. The six cores appear to software as six physical processors. The six-core processors offer considerably higher performance than a same-speed Xeon processor with four cores.

Turbo Boost Technology dynamically turns off unused processor cores and increases the clock speed of the cores in use, by up to two model frequencies. For example, a 2.93GHz 6-core X5670 processor with 3-6 cores active can run the cores at 3.2GHz. With only one or two cores active, the same processor can run those cores at 3.33GHz. Similarly, a 2.26GHz 4-core L5640 processor can run at 2.53GHz, 2.66GHz, or even 2.8GHz. When the cores are needed again, they are dynamically turned back on and the processor frequency is adjusted accordingly.

In processors implementing **Intel Hyper-Threading Technology**, each core has two threads capable of running an independent process. Thus, a 6-core processor can run **12** threads concurrently.

Intelligent Power Capability powers individual processor elements on and off as needed, to reduce power draw.

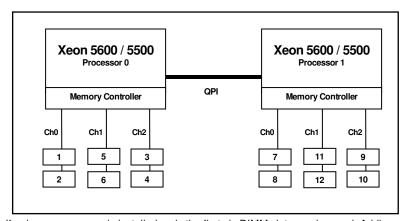
Execute Disable Bit functionality can help prevent certain classes of malicious buffer overflow attacks when combined with a supporting operating system.

Intel's **Virtualization Technology** (VT) integrates hardware-level virtualization hooks that allow operating system vendors to better utilize the hardware for virtualization workloads.

DDR3 Registered Memory with Chipkill ECC Protection

The HS22 uses registered double data rate III (DDR3) VLP (very-low-profile) DIMMs and provides Active Memory features, including advanced **Chipkill** memory protection, for **up to 16X** better error correction than standard ECC memory. In addition to offering **triple the memory bandwidth** of registered or fully-buffered DDR2 memory, DDR3 memory also uses less energy. **1.8V** DDR2 memory already offered up to **37%** lower energy use than fully buffered memory. Now, a generation later, **1.5V** DDR3 memory is even more efficient, using **10-15%** less energy than DDR2 memory. For even greater efficiency, the HS22 also supports **1.35V** DDR3 memory, which uses up to **19%** less energy than 1.5V DDR3 DIMMs.

The HS22 supports up to **192GB** of memory in **twelve** DIMM slots. Redesign in the architecture of the 5500 and 5600 series processors bring radical changes in the way memory works in these servers. For example, the Xeon 5500 and 5600 series processors **integrate the memory controller inside the processor**, resulting in two memory controllers in a two-socket system. Each memory controller has three memory channels. Depending on the type of memory, population of memory, and processor model, the memory may be clocked at **1333MHz**, **1066MHz** or **800MHz**.



Note: If only one processor is installed, only the first six DIMM slots can be used. Adding a second processor not only doubles the amount of memory available for use, but also doubles the number of memory controllers, thus doubling the system memory bandwidth. If you add a second processor, but no additional memory for the second processor, the second processor has to access the memory from the first processor "remotely," resulting in longer latencies and lower performance. The latency to access remote memory is almost 75% higher than local memory access. So, the goal should be to always populate both processors with memory.

The 1333MHz **E**56xx, **L**5640, and **X**56xx processor models support up to 1333MHz memory clock speed and 2 DIMMs per channel (2DPC) at 1333MHz with single-rank and dual-rank RDIMMs and UDIMMs running at 1.5V. Other 5600 series processors access memory at **1066MHz**. The **E550**x models support memory at 800MHz only.

Running memory at 1333MHz (where supported) versus 1066MHz offers up to **9%** better performance, while running memory at 1066MHz produces up to **28%** better performance than memory running at 800MHz.

Xeon 5500 and 5600 series processors access memory with almost **50% lower latency** than the previous generation 5400 series processors. That can result in faster processing of latency-sensitive workloads.

This new processor design comes with some trade-offs in memory capacity, performance, and cost: For example, more lower-cost/lower-capacity DIMMs mean lower memory speed.

Alternatively, fewer higher-capacity DIMMs cost more but offer higher performance.

Regardless of memory speed, the Xeon 5500 platform represents a significant improvement in

memory *bandwidth* over the previous Xeon 5400 platform. At 1333MHz, the improvement is almost **500**% over the previous generation. This huge improvement is mainly due to the dual integrated memory controllers and faster DDR3 1333MHz memory. Throughput at 800MHz is **25 gigabytes per second** (GBps); at 1066MHz it's **32GBps**; and at 1333MHz it's **35GBps**. This improvement translates into improved application performance and scalability.

Memory interleaving refers to how physical memory is interleaved across the physical DIMMs. A balanced system provides the best interleaving. A Xeon 5500 processor-based system is balanced when all memory channels on a socket have the same amount of memory.

In the case of HS22, which has a balanced DIMM layout, it is easy to balance the system for all three memory frequencies. The recommended DIMM population is shown below, assuming DIMMs with identical capacities.

Memory Frequency	DIMMs per Channel	Max. Memory Capacity	5600 Series	5500 Series
1333MHz	2 (12 DIMMs)	192GB	X5650, L5640, E5645 and above	N/A
1066MHz	2 (12 DIMMs)	192GB	All	N/A
800MHz	2 (12 DIMMs)	192GB	N/A	E5503/E5507
800MHz- 1333MHz (Mirroring)	2 (12 DIMMs)	96GB available	All processors	All processors

A memory rank is simply a segment of memory that is addressed by a specific address bit. DIMMs typically have 1, 2 or 4 memory ranks, as indicated by their size designation.

A typical memory DIMM description is 2GB 2Rx8 DIMM:

- The 4R designator is the rank count for this particular DIMM (R for rank = 2)
- The x8 designator is the data width of the rank

It is important to ensure that DIMMs with appropriate number of ranks are populated in each channel for optimal performance. Whenever possible, **it is recommended to use dual-rank DIMMs** in the system. Dual-rank DIMMs offer better interleaving and hence better performance than single-rank DIMMs. For instance, a system populated with six 2GB *dual*-rank DIMMs outperforms a system populated with six 2GB *single*-rank DIMMs by 7% for SPECjbb2005. Dual-rank DIMMs are also better than quad-rank DIMMs because **quad-rank DIMMs will cause the memory speed to be down-clocked**.

Another important guideline is to populate equivalent ranks per channel. For instance, mixing one single-rank DIMM and one dual-rank DIMM in a channel should be avoided.

Note: It is important to ensure that all three memory channels in each processor are populated. The relative memory bandwidth decreases as the number of channels populated decreases. This is because the bandwidth of all the memory channels is utilized to support the capability of the processor. So, as the channels are decreased, the burden to support the requisite bandwidth is increased on the remaining channels, causing them to become a bottleneck.

For peak performance:

- Always populate both processors with equal amounts of memory to ensure a balanced NUMA system.
- Always populate all 3 memory channels on each processor with equal memory capacity.
- Ensure an even number of ranks are populated per channel.
- Use dual-rank DIMMs whenever appropriate.
- For optimal 1333MHz performance, populate 12 dual-rank DIMMs (6 per processor) for processors that support 2 DIMMs per Channel (2DPC)..
- For optimal 1066MHz performance, populate 12 dual-rank DIMMs (6 per processor).
- For optimal 800MHz performance with high DIMM counts, populate 12 dual-rank or quadrank DIMMs (6 per processor) and clock memory down to 800MHz in BIOS.
- With the above rules, it is not possible to have a performance-optimized system with 4GB, 8GB, 16GB, or 128GB. With 3 memory channels and interleaving rules, configure systems with 6GB, 12GB, 18GB, 24GB, 48GB, 72GB, 96GB, etc., for optimized performance.

Power guidelines:

- Fewer larger DIMMs (for example 6 x 4GB DIMMs vs. 12 x 2GB DIMMs) will generally have lower power requirements
- x8 DIMMs (x8 data width of rank) will generally draw less power than equivalently sized x4 DIMMs

Reliability guidelines:

- Using fewer, larger DIMMs (for example 6 x 4 GB DIMMs vs. 12 x 2GB DIMMs is generally more reliable
- Xeon 5500 and 5600 series memory controllers support IBM Chipkill™ memory protection technology with x4 DIMMs (x4 data width of rank), but not with x8 DIMMs

For increased availability, the HS22 offers two additional levels of IBM Active Memory protection: **memory mirroring** and **memory sparing**.

Memory mirroring works much like disk mirroring. The total memory is divided into two channels. Data is written concurrently to both channels. (The third channel is unused.) If a DIMM fails in one of the DIMMs in the primary channel, it is instantly disabled and the mirrored (backup) memory in the other channel becomes active (primary) until the failing DIMM is replaced. With mirroring enabled, one-third of total memory (4 DIMMs) is available for use. (Note: Due to the double writes to memory, performance is affected.) Mirroring is handled at the hardware level; no operating system support is required.

In *memory sparing*, one of the three memory channels (Ch2) for each processor is reserved as a spare for the other two channels (Ch0 and Ch1). This means that unlike mirroring (where one third of the memory is reserved for redundancy and one-third is unused), with sparing only one-third is reserved, leaving two-thirds (8 DIMMs) available as usable memory. *Note:* Although DIMMs within a channel do not have to be identical, the DIMMs in each of the three channels must be identical to the other channels regarding capacity and organization. (In other words, if the DIMMs in Ch0 are 2GB 2Rx4 and 8GB 1Rx8, respectively (all 1.35V), then the DIMMs in Ch1 and CH2 must also be 2GB 2Rx4 and 8GB 1Rx8 (all 1.35V), in that order.)

DDR3 memory is available in **1GB**, **2GB**, **4GB**, **8GB**, and **16GB** DIMMs. DIMMs are installed individually (not in pairs).

Integrated Virtualization

All models of the x3550 M3 support a **USB 2.0 Flash Key** installed preloaded with **VMware vSphere Hypervisor** (formerly ESXi). Rather than management through a Service Console based on a Linux operating system, vSphere Hypervisor relies on aggregate management tools, including VirtualCenter, the Remote Command Line interface and the introduction of CIM for standards-based and agentless hardware monitoring.

vSphere Hypervisor includes all the performance, scalability and compatibility features of a hypervisor installed on disk, including full **VMFS** support across FC SAN, iSCSI SAN, and NAS, and **4-way VSMP**. Because it runs from flash memory, it's extremely fast and ideal for diskless configurations. It also offers enhanced security, because it runs without an operating system-based console and is updated/patched much like firmware.

Disk Controllers

All HS22 models include an integrated LSI 1064E SAS/SATA controller. This controller supports up to two internal SAS or SATA HDDs or two internal solid-state drives and offers hardware RAID-0/1 support. 256MB of optional battery-backed cache memory is available.

An optional **ServeRAID-MR10ie** controller (CIOv form-factor) adds **RAID-5**/50/6/60 support for direct-attach BladeCenter S storage or external **System Storage EXP3000** access, along with **256MB** of cache memory and battery backup. For SAN storage, use the optional IBM **SAS Connectivity Card** (CIOv). For iSCSI storage, use an **Ethernet Expansion Card** (CIOv). For Fibre Channel SAN storage, use an optional **Fibre Channel Expansion Card** (CIOv).

The **SAS** controller provides data transfer speeds of up to **3Gbps** per second⁶ in *each* direction (**full-duplex**) across the SAS bus, for an aggregate speed of **6Gbps**. The serial design of the SAS bus allows maximum performance to be maintained as additional drives are added.

Flexible Internal Storage

The HS22 offers a choice of internal **2.5-inch** storage: up to **two hot-swap SAS** or **SATA** drives or **two hot-swap solid-state** drives:

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⁶ Data transfer rates depend on many factors and are often less than the maximum possible.







2.5-inch SAS HDDs

- 10K RPM 73.4, 146.8, 300, 500, or 600GB capacities (1.2TB maximum)
- 15K RPM 73.4 or 146.8GB capacity (293.6GB)

2.5-inch SATA HDDs

SATA 10K RPM 2.5-inch HDD — 300GB capacities (600GB)

2.5-inch SSDs

• SATA-based —50GB (single) capacities (100GB maximum)

Due to the statistically higher failure rates for traditional spinning media, IBM recommends the use of the solid state drives (SSDs) as an alternative. They store data on flash memory chips, rather than on magnetic media. Like HDDs, SSDs can be used as boot media and for random access storage. However, SSDs offer higher thresholds of shock and vibration, and a higher operating temperature range (between 0 and 70 degrees C). This yields a failure rate only 1/3 that of HDDs (approximately 3,000,000 hours MTBF vs. 1,000,000 hours). In addition, the **2.5-inch SSDs** require only **2W**. This reduces the storage power requirement and heat output by as much as **80%**, compared to 2.5-inch HDDs. If used as a boot device, no special device drivers are required.

High IOPS SSD PCIe Adapters

- o IBM 160GB High IOPS SS Class SSD PCIe Adapter (x4 Gen 1—100K IOPS, 750MBps)
- o IBM 320GB High IOPS SS Class SSD PCIe Adapter (x4 Gen 1—100K IOPS, 750MBps)
- IBM 320GB High IOPS MS Class SSD PCIe Adapter (x4 Gen 1—100K IOPS, 750MBps)
- o IBM 320GB High IOPS SD Class SSD PCIe Adapter (x8 Gen 2—200K IOPS, 1.5GBps)
- o IBM 640GB High IOPS MLC Duo Adapter (x8 Gen 2—200K IOPS, 1.5GBps)

For read-intensive transactional workloads requiring extreme IOPS performance, such as database, video-on-demand, and caching, IBM offers **High IOPS SSD PCIe Adapters**, equivalent to the IOPS output of approximately 500^7 3.5-inch 600GB 15K SAS HDDs, with 99% **lower latency** (30 µs), and 7.7x the bandwidth of a HDD. On a performance-per-watt basis, these adapters outperform HDDs by up to $445x^8$.

Because these adapters go in PCIe slots, rather than drive bays, they can be used *in addition* to standard HDDs and SSDs. This makes them ideal for virtualized servers running multiple tasks, requiring both write- and read-intensive storage media. As flash media they also offer a predictable lifetime, compared to the sporadic failure rate of HDDs, using N+1 chip-level redundancy and 11-bit ECC protection.

Note: The High IOPS Adapters require a BPE4 expansion unit.

Additional storage is available via the BladeCenter S chassis.

If you need more storage space, terabyte capacities are possible with optional external iSCSI and SAN storage solutions.

External Tape Storage

The HS22 supports various external rack-mounted SAN-attached tape drives. Supported tape technologies include:

- IBM LTO3 2U Autoloader
- IBM LTO3 4U Tape Library
- IBM System Storage TS2230 Express Tape Drive
- IBM System Storage TS2240 Tape Drive Model H4S
- IBM System Storage TS3100 or TS3200 Tape Library
- IBM System Storage TS3310 Modular Tape Library



Light Path Diagnostics

Light path diagnostics enables a technician to quickly identify and locate a failed or failing system component, such as a specific blower module or memory DIMM. This enables quick replacement of the component, which helps increase server uptime and lower servicing costs.

The front of each blade server—and the chassis itself—has an LED indicator light to show

⁸ 97,014 IOPS / 9W = 10,779 IOPS per watt (160GB/320GB adapters). 196,000 IOPS / 12W = ~16,333 IOPS per watt (640GB adapters). 400 IOPS / 16.5W = ~24 IOPS per watt (600GB 15K 3.5-inch hot-swap SAS HDD).



According to internal IBM testing, the typical maximum IOPS of a 600GB 15K 3.5-inch hot-swap SAS HDD is ~400 (4K random reads), while the typical IOPS of a 640GB High IOPS SSD PCIe adapter is ~200,000, or ~500x. The typical bandwidth of the same HDD = ~195MBps (64K sequential reads), while the typical bandwidth of a 640GB High IOPS MLC adapter is ~1.5GBps, or ~7.7x.

possible component failures. This lets the servicer identify the failing component without the need to or remove the blade server from the chassis. The light path diagnostics panel tells the servicer which component of the affected server requires attention.

In addition, many components have their own identifying LEDs. For example, each of the memory modules has an LED next to the socket, as do both processors. This allows the servicer to easily identify exactly which component needs servicing. By following the "light path," the component can be replaced quickly, and without guesswork. (*Note:* In the event of a failed DIMM, the system will restart and mark the DIMM as bad while offline, thus allowing the system to continue running, with reduced memory capacity, until serviced.)

Gigabit Ethernet Controllers

The HS22 includes a **dual-port** integrated **Broadcom BCM5709S** Gigabit Ethernet controller for up to 10X higher maximum throughput than a 10/100 Ethernet controller. The controller offers **TOE** (TCP Offload Engine) support, as well as **failover** and **load balancing** for better throughput and system availability. It also supports highly secure remote power management using **IPMI 2.0**, plus Wake on LAN® and PXE (Preboot Execution Environment) Flash interface.

For additional Gigabit Ethernet controllers, an optional **2-port** or **4-port Ethernet** expansion card adds additional Gigabit Ethernet ports.

High-Performance Adapter Slots

The HS22 blade server includes **two x8 PCIe** adapter slots. They support **CFF** (compact form factor) cards: one standard-speed **CIOv** and one high-speed **CFFh**.

The BladeCenter PCI Express I/O Expansion Unit 3 (BPE3) adds 2 standard full-height/full-length x16 physical/x8 electrical (4GBps) PCIe Gen 1 expansion card slots, supporting adapters of up to 25W apiece to an HS22. One BPE3 can be connected per HS22 blade, for a total of 3 available slots (1 in the blade and 2 in the expansion unit). *Note:* The BPE3 reserves the high-speed CFFh expansion connector in the HS22, leaving only the CIOv slot available.

Similarly, the optional BladeCenter PCI Express Gen 2 Expansion Blade (BPE4) adds 1 standard full-height/full length and 1 standard full-height/half-length x16 physical/x8 mechanical (8GBps) PCIe Gen 2 expansion card slot per HS22 blade. These slots support two industry-standard PCIe adapters, up to 75W per adapter. The BladeCenter PCI Express Gen 2 Expansion Blade offers a unique stacking feature that allows clients to stack up to 4 expansion blades per HS22 blade, offering up to an additional 8 PCIe slots per HS22 blade. *Note:* Unlike the BPE3, the BPE4 does *not* reserve the high-speed CFFh expansion connector in the HS22, leaving *both* slots available in the server.

If I/O slots are a greater need than processors or memory, attaching multiple I/O expansion units to one blade server is much more cost-effective than installing multiple blade servers for the same number of adapter slots. (*Note:* A maximum of *one* CFFh card is supported.)

Common PCIe adapters used to connect to BladeCenter switch modules, include Fibre Channel, additional Gigabit Ethernet cards, 10Gb Ethernet, Converged Network Adapters (CNAs), InfiniBand, SAS, etc.

BladeCenter Chassis

IBM's blade architecture offers *five* choices of compatible and interoperable chassis in which to use various blade servers. Each chassis serves different customer needs. The new **BladeCenter S** is a small, entry-level chassis designed for office environments. The original **BladeCenter E** chassis offers maximum density, great flexibility and a wide variety of expansion options at an entry-level price. The next-generation **BladeCenter H** chassis offers all of BladeCenter's capabilities, and adds new high-performance features. If you need a **ruggedized** chassis (for example, government/military or telecom), **BladeCenter T** offers special features optimized for those environments. (*HS22 is not supported in the BladeCenter T*.) The next-generation **BladeCenter HT** is a high-performance **ruggedized** telecommunications platform. There is a high degree of interchangeability and compatibility of features among the chassis. Any or all of these chassis can be installed in a rack along with other rack-optimized equipment.

See the separate BladeCenter Chassis Sales Guide for details.

Hot-Swap/Redundant Components

System availability is maximized through the extensive use of hot-swap and redundant components, both in the blade server and in the various BladeCenter chassis, including:

- Redundant memory protection (with Chipkill error correction and memory mirroring or memory sparing enabled)
- Hot-swap, redundant hard disk drives and solid-state drives (with RAID protection)
- · Hot-swap, redundant power supply modules





- · Hot-swap, redundant cooling fan/blower modules
- · Hot-swap, redundant switch modules
- · Redundant midplane connectors between blades and modules

Energy-Smart Features

IBM servers work hard to keep your energy bills low—from high-efficiency power supplies and fans to lower-draw processors and memory. Technologies such as these, along with the Xeon 5500/5600 series processors that intelligently adjust their voltage and frequency, help take costs out of IT:

- 40W 4-core processors use 50% less energy than 80W processors and 69% less than 130W processors.
- 60W 6-core processors use 37% less energy than 95W processors and 54% less than 130W processors.
- 1.5V DDR3 DIMMs consume 10-15% less energy than 1.8V DDR2 DIMMs used in older servers.
- 1.35V DDR3 DIMMs consume up to 19% less energy than 1.5V DDR3 DIMMs.
- Solid-State Drives consume up to 80% less energy than 2.5-inch HDDs and up to 88% less than 3.5-inch HDDs.
- Operating at as much as 94% efficiency, high efficiency power supplies use less energy than
 competitive power supplies that average only 70-80% efficiency, and produce less waste heat that
 needs to be cooled.
- **Dynamic fan speeds** In the event of a fan failure, the other fans will run faster to compensate until the failing fan is replaced. Competitive fans must run faster at all times, just in case, wasting power.

Advanced Systems Management Capabilities

Each BladeCenter chassis offers a high level of systems management capabilities that are well-suited to remote locations as well as to stand-alone environments. Features include the Advanced Management Module (AMM), Integrated Management Module (IMM), Automatic Server Restart, Systems Director Active Energy Manager for x86, Wake on LAN® support, PXE 2.0 support, text and graphics console redirect, Predictive Failure Analysis, Embedded Dynamic System Analysis, and IBM Systems Director.

The chassis-based **AMM**, in combination with the HS22 blade server's **IMM**, provides industry-standard **Intelligent Platform Management Interface (IPMI) 2.0**-compliant systems management. The AMM provides a number of important system functions, including:

- Monitoring of system and battery voltage, system temperature, fans, power supplies, processor and DIMM status
- Fan speed control
- · Product ID and Family ID detection
- Highly secure remote power on/off
- · System reset control
- · NMI/SMI detection and generation
- System diagnostic LED control (power, HDD, activity, alerts, heartbeat)
- IPMI over LAN
- Serial Over LAN
- Proxy server support
- LAN messaging and alerting
- VLAN support
- Enhanced authentication and encryption algorithms (RMCP+, SHA-1, AES)
- · Local update of IMM firmware
- Firmware firewall
- Support for IPMI v2.0 compliant management software (e.g., xCAT)
- Other mandatory and optional IPMI functions in the blade's IMM

The IMM, via the management module, alerts IBM Systems Director to anomalous environmental factors, such as voltage and thermal conditions—even if the server has failed.

Other systems management features offered for the combination of blade server and chassis include:

· Predictive Failure Analysis for system processors, memory and HDDs, as well as chassis switch

modules, blower modules and power modules

- Web-based out-of-band control
- · Windows "blue screen" capture
- · Remote virtual media
- · High-speed remote redirection of PCI video, keyboard and mouse
- SSL (Secure Socket Layer) and LDAP (Lightweight Directory Access Protocol) support

In order to put control of processor power-saving features at the fingertips of administrators, IBM developed IBM Systems Director Active Energy Manager. Active Energy Manager is designed to take advantage of new processor features, such as balancing the performance of the system according to available power input. It provides the ability to plan and predict power consumption based on your BladeCenter hardware configuration. It also helps you reduce the infrastructure required for redundancy, by using fewer servers on smaller power feeds and potentially lowering your overall data center support costs. It does this by inventorying all components at the blade level, then adding up the power draw for each blade and tracking that usage. In failure mode, Active Energy Manager (through the BladeCenter Management Module) might request that certain blades in each domain throttle down to reduce power consumption.

Automatic Server Restart (ASR) helps reduce downtime by restarting the server automatically in the event of a system lockup. ASR technology is a combination of hardware circuitry tied into the server's system reset function and a device driver. As long as the server continues running, the ASR watchdog timer will keep being reset, but if the operating system crashes or the hardware freezes somehow the ASR software will be unable to reset the hardware timer. If the timer is not reset within five minutes, it automatically triggers the ASR hardware, which immediately restarts the server (and logs an ASR event with IBM Systems Director). These features are designed so that *no more than five minutes can pass before the server is restarted*.

Text and Graphics Console Redirect support allows the administrator to remotely view HS22 text and graphics messages over serial or LAN.

Wake on LAN permits the server to be remotely powered on if it has been shut off. Once powered up, the server can be controlled across the network, using the **Preboot Execution Environment** (PXE).

Like Wake on LAN, **PXE** is system firmware. It allows software such as the **IBM Remote Deployment Manager** to take control of a system before the BIOS, operating system or applications are loaded (using Wake on LAN/PXE) and lets an administrator perform many low-level tasks remotely that would otherwise require a visit to each system. These tasks may include such things as formatting a hard disk drive, updating system firmware, or deploying a Windows or Linux operating system.

Predictive Failure Analysis (PFA) enables the MM/AMM and the IMM to detect impending failure of supported components (processors; memory; expansion cards; switch, blower and power supplies; and hard disk drives) before actual failure, and alert the administrator through IBM Systems Director. This gives you the ability to replace the failing component *before* it fails, resulting in increased uptime.

Embedded Dynamic System Analysis (DSA) feature collects and analyzes system information to aid in diagnosing problems. The diagnostic programs collect the following information:

- System configuration
- Network interfaces and settings
- Installed hardware
- · Service processor status and configuration
- Vital product data, firmware, and BIOS configuration
- Hard disk drive health
- RAID controller configuration
- Event logs for ServeRAID controllers and service processors

The diagnostic programs create a merged log that includes events from all collected logs. The information is collected into a file that you can send to IBM service and support. Additionally, you can view the information locally through a generated text report file, or you can copy the log to removable media and view the log from a Web browser.

IBM Systems Director software for advanced workgroup management is included with the server. IBM Systems Director comes with a portfolio of tools, including *Active Energy Manager*, *Service and Support Manager*, *and other tools. System Availability* (a no-charge download) and *Capacity Manager* (sold separately) are available as add-ons for additional server management and increased availability. IBM Systems Director provides a single uniform graphical interface for all of these systems management functions.

IBM Systems Director enables you to customize thresholds and monitor system components (for things like temperature, voltage regulation, etc.) to help maximize uptime.

Extensive System Support Features

The IBM services and technical support portfolio provides world-class, consistent, high-quality service and support. From the start, IBM programs make it easier for you to plan for, configure and purchase BladeCenter servers, get them running and keep them running long-term. These features include IBM ServerProven®, IBM Standalone Solutions Configuration Tool, IBM System x and BladeCenter Power Configurator, IBM ServerGuide, IBM Systems Director Service and Support Manager, Product Customization Services and extensive technical support offerings.

The IBM **ServerProven** program provides the confidence that specific options and operating systems have been tested on the blade servers and chassis and are officially supported to work together. It is updated frequently to keep the latest compatibility information at your fingertips.

The IBM **Standalone Solutions Configuration Tool** (SSCT) is a downloadable tool that simplifies the often complex chore of configuring a full rack of servers (including blade servers) and confirming that you have all the cables, power distribution units, KVM (keyboard, video and mouse) switch boxes and other components you need, as well as the proper airflow clearances, electrical circuits and other environmental conditions.

IBM **System x and BladeCenter Power Configurator** helps IT managers plan for data center power needs, by providing the following information for specific configurations of System x and BladeCenter systems: *power input* (watts), *PDU sizing* (amps), *heat output* (BTUs), *airflow requirements through chassis* (CFM), *VA rating*, *leakage current* (mA), and *peak inrush current* (amps).

IBM **ServerGuide** (installed from CD) simplifies the process of installing and configuring System x servers. ServerGuide goes beyond mere hardware configuration by assisting with the automated installation of the Microsoft[®] Windows[®] Server 2000 and 2003 operating systems, device drivers and other system components, with minimal user intervention. (Drivers are also included for support of Novell NetWare, Red Hat Linux and SUSE LINUX.) This focus on deployment helps to reduce both your total cost of ownership and the complexity that administrators and technical personnel face.

IBM Systems Director Service and Support Manager (previously called IBM Electronic Service Agent) is an innovative "call home" feature that allows System x and BladeCenter servers to automatically report hardware problems to IBM support, which can even dispatch onsite service if necessary to those customers entitled to onsite support under the terms of their warranty or an IBM Maintenance Agreement. Service and Support Manager resides on a server and provides electronic support and problem management capabilities through a highly secure electronic dialogue between your systems and IBM. It monitors networked servers for hardware errors and it can perform hardware and software inventories and report inventory changes to IBM. All information sent to IBM is stored in a highly secure database and used for improved problem determination.

Additional services include hardware warranty upgrades and factory-installed **Product Customization Services** (PCS), such as asset tagging, hardware integration, software imaging and operating systems personalization.

IBM offers extensive **technical support** by phone and via the Web. Support options include links to forums/newsgroups, problem submission, online shopping support, service offerings, device drivers for all IBM product lines, software downloads and even upcoming technical seminar worldwide schedules and registration. Also available are remote installation, configuration and usage support for both System x hardware and software, as well as onsite custom services to provide the level of expertise you require.

IBM Maintenance and Technical Support solutions can help you get the most out of your IT investment by reducing support costs, increasing availability and simplifying management with integrated support for your multiproduct, multivendor hardware and software environment. For more information on hardware maintenance, software support, solution support and managed support, visit http://ibm.com/services/maintenance.

Key Options

m-Server_{Proven}

IBM options for System x servers let you take your servers to a higher level

You can rely on System x and blade options to supply a comprehensive solution for your business needs. Options help create an optimized server system to meet your data protection, storage and availability needs. Every IBM option is designed and tested for peak performance and flexibility, helping to maximize your return on investment. The combination of System x servers and options lets you keep your fingers on the pulse of your e-business.

Processors — The Intel Xeon processor provides high clock rates, 64-bit extensions, a large cache, Hyper Threading Technology, Turbo Boost Technology, energy-saving features, and

⁹ For onsite labor, IBM will attempt to diagnose and resolve the problem remotely before sending a technician.

advanced features for availability and manageability. Large cache size and multiple cores, combined with a **1066MHz** or **1333MHz** memory access speed, reduce memory latency and facilitate the movement of data through the processor and I/O devices. (*Note:* System performance depends not only on the number of processors in the server but also on the power and functionality of each processor, as well as the number, capacity, and arrangement of the DIMMs.) Adding a second processor may be a cost-effective way to achieve significant performance improvements.

Memory — Memory is a significant factor in systems application performance. Adding more memory to a BladeCenter server is one of the most effective ways to increase application performance. For best performance in a server with a quad-core processor, there should be twice as much memory available as for a dual-core processor. **Note:** Fewer large-capacity DIMMs may provide better performance and use less energy than more lower-capacity DIMMs.

I/O Expansion Units — A choice of BladeCenter PCI Express Expansion Unit 3 (BPE3) or BladeCenter PCI Express Gen 2 Expansion Blade (BPE4) offers from 3 to 10 total adapter slots per HS22 server, to support additional fabrics (including Ethernet, 10Gb Ethernet, Fibre Channel, SAS, and Converged Network Adapters), and high-performance graphics processing units (GPUs).

Hard Disk Drives — IBM hard disk drives help you improve the transaction and cost performance of your HS22 servers. The choice of hard disk drives can be a critical aspect of maximizing the I/O throughput of the system. Hot-swap SAS hard disk drives (2.5-inch) are available for the HS22 with capacities up to 300GB at 10,000 RPMs or up to 146.8GB at 15,000 RPMs. Hot-swap SATA hard disk drives (2.5-inch) are available for the HS22 with capacities up to 300GB at 10K RPMs. Additional direct-attach storage is available via the BladeCenter S chassis.

Solid-State Drives — IBM offers a **50GB** 2.5-inch **solid-state drive** as an alternative to internal HDDs. It can be used as a highly available boot drive or for storing disk images, or for other primarily read-only uses.

High IOPS SSD PCIe Adapters — For storage media offering up to 500 times the I/O operations per second (IOPS) and up to 7.7 times the bandwidth of 15,000-RPM HDDs, IBM offers the 160GB High IOPS SS Class SSD PCIe Adapter, the 320GB High IOPS SS Class SSD PCIe Adapter, the 320GB High IOPS MS Class SSD PCIe Adapter, and the 320GB High IOPS SD Class SSD PCIe Adapter, as well as the 640GB High IOPS MLC Duo Adapter. These adapters offer near-DRAM performance, with extremely high data retention (up to 25 years) and RAID-grade data protection, with 160GB or 320GB capacities.

ServeRAID Controllers — System x servers using ServeRAID technology allow organizations to build a reliable foundation for business-critical computing. IBM ServeRAID technology allows an array consisting of multiple physical hard disk drives to be treated as one logical drive. ServeRAID technology also allows data to be stored redundantly, across multiple hard disk drives— enhancing both the integrity and the availability of the data. SAS and SATA ServeRAID controllers offer enhanced performance due to onboard processors and cache. Because IBM ServeRAID controllers can help significantly improve data transfer rates, this technology is extremely effective when implementing demanding, transaction-oriented applications. By employing the advanced fault tolerance of IBM ServeRAID technology, companies can effectively implement networked business systems that require large amounts of storage space for data and applications that must be available for their businesses to continue operating.

The optional **ServeRAID-MR10ie** controller (ClOv form-factor), with up to **6Gbps** throughput per SAS port, adds **RAID-5/50/6/60** support and **256MB** of cache memory and battery backup, as well as support for direct-attach **BladeCenter S** storage or external **System Storage** expansion units.

External Storage — The IBM System Storage DS3000, DS4000, DS5000, and DS8000 series, as well as the System Storage N3000, N5000, N6000, and N7000 series, comprise a powerful and broad shared storage family with integrated management software designed to meet midrange and enterprise needs. For lower-end needs, IBM offers the System Storage EXP810 and EXP3000 storage expansion units.

Additionally, external LAN-attached tape storage is available.

Communication Modules — The various BladeCenter chassis support integrated communication and I/O switches and/or bridges for Gigabit and 10Gb Ethernet, Myricom, 4Gb and 8Gb Fibre Channel, 1X and 4X InfiniBand, iSCSI, 3Gb SAS, and others. Expansion adapters for individual HS22 blades are available to interface with these modules. The BladeCenter H and BladeCenter HT also support the Multi-Switch Interconnect Module, which doubles the number of Gigabit Ethernet and Fibre Channel connections available to all blades in the chassis.

Rear Door Heat eXchanger — The unit attaches to the back of an IBM S2 42U Enterprise Rack. It is capable of removing up to 50,000 BTUs (14KVa) from the data center using water lines under the raised floor. The door swings open for servicing.

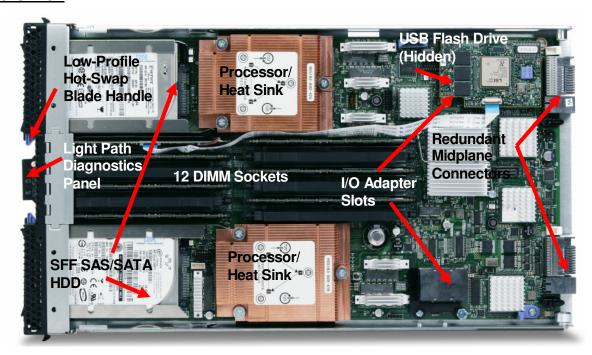
Redundant features — Optional hot-swap drives, power supply modules, blower modules, management modules, switches and bridges provide redundancy for the various BladeCenter chassis.

HS22 Images

Front View



Interior View



BladeCenter HS22 Specifications				
Machine type	7870- Axx, Bxx, Cxx, Dxx, Fxx, Gxx, Hxx, Nxx (plus CTO and special bid)			
Form factor	30mm blade			
Processor type	Six-core Xeon (E56xx/L56xx/X56xx) 2.0GHz L5630 (CTO),	Four-core Xeon (E56xx/L56xx/X56xx) 1.6GHz E5603 (A5x),	Two-core Xeon (E55xx) 2.00GHz E5503 (D3x)	

	BladeCente	r HS22 S	Speci	fication	ns			
	2.26GHz L5640 (N2x), 2.4GHz E5645 (CTO), 2.53GHz E5649 (B6x), 2.66GHz X5650 (H2x/HAx), 2.93GHz X5670 (H4x), 3.06GHz x5675 (C6x), 3.33GHz X5680 (F2x), 3.46GHz X5677 (F3x) , 3.46GHz X5690 (C8x) 3.2GHz X5697 (C8x)		6609 (CTC 18 (spec 5606 (CTC 5607 (A7: 5620 (G2: 5640 (G4: 5647 (B5: 5667 (H5: 672 (C5x	bid), C), x), x), x), x), x), x),	Four-core Xeon (E55xx) 2.26GHz E5507 (A4x)			
Processor power draw	130W (B5x, C7x/C8x, F2x/F3x)	95W (C5x, H2x/H4x/l HAx)			DW (N2x, : L5630 via : CTO)	40W (L5609. a L5618 via CTO)		
Internal cache				d cache (A4x/A5x/A7x, D3x, us E5606 via CTO)				
QuickPath Interconnect (QPI) speed (gigatransfers per second)	6.4 GTps (B6x, C5x/C6x/ C7x/C8x, F2x/F3x, H2x/H4x/H5x/HAx) 5.86 GTps (A5 G2x/G4x/GCx E5606/E5645 CTC			x, N2x, p 5, L5630	, plus 4.8 GTps (A4x/A5x/A7x,			
Maximum memory access speed	1333MHz (B6x, C5x/C6x/ C7x/C8x, F2x/F3x, H2x/H4x/H5x/HAx, N2x, plus E5645, L5630 via CTO)		1066MHz (A5x/A7x, B5x, G2x/G4x/GCx, plus E5606, L5609/L5618)		800MHz (A4x/A5x/A7x, D3x, plus E5606 via CTO)			
# of processors standard / maximum	1/2							
NEBS/ETSI Compliance	Select blades are NEBS3/ETSI-compliant. (Contact IBM sales for details.)					for details.)		
Chipset				Intel	5520			
Standard / maximum memory ¹⁰	12GB (3 x 4GB) / 192GB (F 288GB (B5x/B6x, G2x/G4 C5x/C6x/C7x/C8x) H2x/H4x/F		GB (F2 x/G4x/ H4x/H5	G (3 x 2GB) / GB (F2x/F3x, v/G4x/GCx, 14x/H5x/HAx, N2x) GB (1 x 4G 288GB (A5x)			3GB (3 x 1GB) / 192GB (A4x, D3x)	
Standard memory type	Registered DDR3 ECC (operating at 1333MHz, 1066MHz or 800MHz, depending on processor and memory configuration)							
Memory interleaving	Yes							
DIMM capacities supported	1GB, 2GB, 4GB, 8GB (when available)							
Chipkill protection supported	Yes (using x4 DIMMs)							
# of DIMM sockets total / available	12/9							
# of 2.5-inch drive bays total / available	2 / 2 SAS/SATA/SSD							
# of 3.5-inch drive bays total / available	None							
Maximum internal 2.5" HDD capacity	Standard 1.2TB (2 x 600GB) hot-swap							

¹⁰ Maximum memory and disk capacity may require the replacement of standard components with the largest supported component available.

BladeCenter HS22 Specifications						
2.5-inch drive capacities supported	SAS 73.4, 146.8, 300, 500, 600GB — 10K RPMs; 73.4, 146.8GB — 15K RPMs	<u>SAT.</u> 300, 500GB — SFF H	10K RPMs	<u>Solid-State</u> 50GB		
# of HDDs standard	None					
Additional Internal SSD storage via PCle adapter	160GB High IOPS SS Class SSD PCIe Adapter 320GB High IOPS SS Class SSD PCIe Adapter 320GB High IOPS SD Class SSD PCIe Adapter 320GB High IOPS MS Class SSD PCIe Adapter 640GB High IOPS MLC Duo Adapter			Adapter Adapter Adapter		
Internal USB Flash Drive	Optional 2GB (preloaded with VMware vSphere Hypervisor (formerly ESXi))					
# of optical drives standard		None (one standa	ard in chassis)			
# of diskette drives standard	None (one stand	ard in BladeCente	er E or BladeC	Center H chassis)		
Internal tape drives supported	None (SAN-attached)					
Disk drive technology		SAS/SA	ATA			
Integrated disk controller	LSI Logic 53C1046E					
Optional RAID controller	ServeRAID-MR10ie					
RAID levels supported	RAID-0/1 (standard)					
External disk drive support	NAS/SAN-attach					
# of PCIe slots	2 x16 mechanical/x8 electrical slots included (up to 3 total using 1 BladeCenter PCI Express I/O Expansion Unit 3 (BPE3) blade)		2 x16 mechanical/x8 electrical slots included (up to 10 total using 4 BladeCenter PCI Express Gen 2 Expansion Blade (BPE4) blades)			
# of PCI-X slots	None					
# of legacy PCI slots	None					
# of video ports	None (chassis-attached)					
Video controller	Matrox G200eV (in IMM)					
Video memory	16MB SDRAM					
Maximum video resolution at 32-bit color	1600 x 1200 x 16-bit color at 85Hz			łz		
Gigabit Ethernet controllers standard	Dual-port Broadcom BCM5709S—TOE-enabled					
# of Gigabit Ethernet ports	2 (standard)			Maximum 12 ¹¹		
# of RS485 ports	None					
# of serial ports	None (1 direct via BladeCenter H chassis, or Serial over LAN in BladeCenter E and BladeCenter H)					
# of parallel ports	None					
# of mouse ports	None (1 via chassis)					
# of keyboard ports	None (1 via chassis)					
# of USB ports	1 (plus 2 via chassis)					
Systems management controller		Integrated Manag	ement Module)		

¹¹ Using the **4-Port Ethernet Expansion Card**, an **I/O Expansion Unit**, and a **Multi-Switch Interconnect Module** in a BladeCenter H chassis.

	BladeCenter HS22 Specifications		
Diagnostic LEDs (front panel)	Power good, blade location, over temperature, information, general fault		
Predictive Failure Analysis support	Processor, memory, HDDs, expansion cards		
BIOS type	UEFI 2.1		
Power supply size	Contained in chassis		
# of power supplies standard / maximum	Contained in chassis		
# of fans/blowers standard / maximum	Contained in chassis		
Dimensions (HWD) / weight	9.7" (245mm) H 1.14" (29mm) W 17.6" (446mm) D	12 lbs (maximum) 5.44 kg (maximum)	
Operating systems supported	Microsoft Windows Server 2008, Microsoft Windows Small Business Server 2008, Microsoft Windows Server 2003 and R2 (Standard/Web/Enterprise Editions) 32-bit and 64-bit, RHEL 5.3 32-bit and 64-bit—with or without Xen, RHEL 5.3 32-bit, SLES 11 32-bit and 64-bit—with or without Xen, Sun Solaris 10, VMware vSphere Hypervisor 3.5/4.0 Update 4		
Extended/long life support	Select blades are supported for long life. (Contact IBM sales for details.)		
Length of limited warranty	3 years (parts and labor) onsite		

The Bottom Line

The HS22 offers maximum bang for the buck by incorporating outstanding features in a tiny package:

Price/Performance:

- Multi-core processors Up to two 2.0 to 3.46GHz six-core or 1.6 to 3.6GHz four-core Xeon 5600 series processors; or 2.26GHz four-core or 2.0GHz two-core Xeon 5500 series processors
- Low-voltage processors Up to two 60-watt six-core or 40-watt four-core Xeon 5600 series processors
- Large cache Up to 12MB of L3 processor cache (processor-specific)
- Embedded virtualization via optional internal flash drive
- Fast memory access 1333MHz, 1066MHz, or 800MHz access (depending on the processor model and DIMMs used); 1333GHz memory access even with 2 DIMMs per channel (processorspecific)
- Fast memory access 1333MHz or 1066MHz registered DDR3 ECC memory
- Fast disk technology Internal SAS or SATA storage (2 HDDs) or BladeCenter S chassis;
 RAID-0 data striping
- High-IOPS technology Optional High IOPS SSD adapters
- Fast I/O 10Gb Ethernet, 10Gb CNA, 4X InfiniBand, 6Gb SAS, or 8Gb Fibre Channel connectivity via an optional expansion card
- Fast communications Integrated dual Gigabit Ethernet, with the option for two or four additional
 Gigabit Ethernet ports via expansion cards and expansion unit (total 12 ports per blade); support for
 10Gb Ethernet

Flexibility:

- Single- to five-wide configurations (blade server and up to 4 I/O expansion units)
- Large memory capacity Up to 192GB standard using twelve 8GB DIMMs
- · A choice of hard disk or solid-state storage
- **High-capacity disk storage** Up to **1.2TB** of internal **SAS** or **1TB** of **SATA** storage, with the option for additional 2.5-inch SAS HDDs in the **BladeCenter S chassis**
- Optional IBM 50GB Solid State Drive as an energy-saving alternative to HDD storage
- Optional IBM 160GB, 320GB, or 640GB High IOPS SSD Adapters for extremely high IOPS and bandwidth storage (requires BPE4 expansion unit)
- Integrated RAID RAID-1 mirrored arrays standard; enhanced RAID-1E/5 arrays optional using a BladeCenter S chassis; RAID-5 arrays also available using an optional ServeRAID-MR10ie

- Two available adapter slots standard:
 - Two CFF (compact form factor) slots: one high-speed CFFh and one standard-speed CIOv
- Additional optional adapter slots 12:
 - Up to 3 total, using 1 BladeCenter PCI Express I/O Expansion Unit 3 blade
 - Up to 10 total, using 4 BladeCenter PCI Express Gen 2 Expansion Blades (BPE4) blades

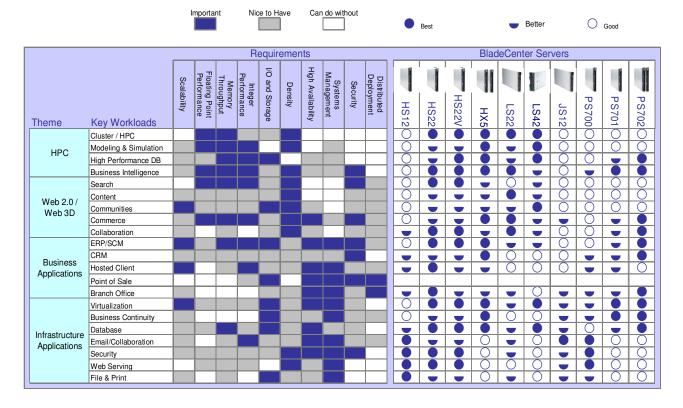
Manageability and Availability:

- **IBM Systems Director** systems management software, including:
 - IBM Systems Director Active Energy Manager
 - **IBM Service and Support Manager**
- Integrated Management Module:
 - IPMI 2.0 compliance, including highly secure remote power control

 - Advanced management capabilities
- Interface to one or two Advanced Management Modules in the chassis for advanced systems management capability
 - Supports LDAP and SSL industry standards
 - Text and graphics console redirection systems management
 - Serial over LAN
- Optional solid-state drive as a high-reliability alternative to internal storage (with up to three times the MTBF of spinning disk drives)
- Numerous hot-swap/redundant capabilities provided via the chassis

Server Comparison Chart

The following table shows the suggested uses for the respective IBM BladeCenter blade servers, including comparisons of the uses for which each server is best suited:



¹² The PCIe expansion units each require an adjacent blade slot.



For More Information

IBM BladeCenter Servers and Options

IBM Systems Director Service and Support Manager

IBM System x and BladeCenter Power Configurator

IBM Standalone Solutions Configuration Tool

IBM Configuration and Options Guide

IBM ServerProven Program

Technical Support

Other Technical Support Resources

http://ibm.com/systems/bladecenter

http://ibm.com/support/electronic

http://ibm.com/systems/bladecenter/resources/powerconfig.html

 $\underline{http://\textbf{ibm.com}/systems/x/hardware/configtools.html}$

http://ibm.com/systems/x/hardware/configtools.html

http://ibm.com/systems/info/x86servers/serverproven/compat/us

http://ibm.com/server/support

http://ibm.com/systems/support

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Some machines are designed with a power management capability to provide customers with the maximum uptime possible for their systems. In extended thermal conditions, rather than shutdown completely, or fail, these machines automatically reduce the processor frequency to maintain acceptable thermal levels.

MB, GB and TB = 1,000,000, 1,000,000,000 and 1,000,000,000,000 bytes, respectively, when referring to storage capacity. Accessible capacity is less; up to 3GB is used in service partition. Actual storage capacity will vary based upon many factors and may be less than stated.

Performance is in Internal Throughput Rate (ITR) ratio based on measurements and projections using standard IBM benchmarks in a controlled environment. The actual throughput that any user will experience will depend on considerations such as the amount of multiprogramming in the user's job stream, the I/O configuration, the storage configuration and the workload processed. Therefore, no assurance can be given that an individual user will achieve throughput improvements equivalent to the performance ratios stated here.

Maximum internal hard disk and memory capacities may require the replacement of any standard hard drives and/or memory and the population of all hard disk bays and memory slots with the largest currently supported drives available. When referring to variable speed CD-ROMs, CD-Rs, CD-RWs and DVDs, actual playback speed will vary and is often less than the maximum possible.

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